高能物理偵測器

Stathes Paganis (NTU) TWHEP 台南, 21 January 2021

兩個大類 (HEP=高能物理)

- 對撞機實驗偵測器
 - Gas Chambers, Silicon trackers, Calorimeters
- 非對撞機實驗偵測器 (台灣)
 - Germanium blocks
 - Very Large custom PMTs
 - 其他 (參閱昨天的演講)
- γ-ray 伽瑪射線偵測器: 100KeV to few MeV
 - Crystals (Nal, LYSO, ...) + PMT
- UV 紫外線, X-光 (few eV to few KeV)
- CMOS 技術 back illuminated (down to 250eV)
- Near IR (includes single photon) 紅外線
 - Silicon (MPPCs) (矽)
 - Super-conducting nano-wires (to λ=1.5µm)
- Far IR (down to λ =1000µm)
 - TES Bolometers (Superconducting)

Applications:

- Medical Imaging,
- Quantum Optics,
- Quantum Information R&D
- -• Quantum Cryptology
 - Deep Space Commun.
 - Dark Matter Search
 - Astronomy, etc.

大型強子對撞機 (LHC)



+ BELLE (日本), STAR, sPHENIX (美國)

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對撞機 實驗: ATLAS, CMS, BELLE, STAR



請參閱這會議的相關演講

非對撞機實驗: TEXONO, CDEX, Juno 等

TEXONO Program: HEP-Hardware Plans (2020—2030)

[not including Gravity Physics Programs]



R&D Towards Formulation of Ton-scale Neutrinoless Double Beta Decay Experiments at China Jinping Underground Laboratory as part of LEGEND Program





Gaseous Tracking Detectors

- Multi Wire Proportional Chambers
- Drift Chambers
- Time Projection Chambers
- MSGC, GEMS and moving on to Silicon





Primary ionisation pairs
 Secondary ionisation pairs

Gas electron multipliers (GEM)



Thin perforated kapton foil, metal clad on both sides. (~500V)

Field lines squeezed through small gaps. This causes gas amplification in the gap.

Less gas amplification needed near the anode strips. Invented to rescue MSGC technology.





Advantage: with multiple GEM foils no need for charge multiplication near anode.

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Solid-state tracking detectors (砂)

• Semi-conductors: reverse-bias pn-junction diode



Calorimeters



Other cutting-edge Technologies

- **SPAD**: Single Photon Avalanche Diodes
 - Timing: 100ps, large dead time (200ns), up to MHz rate.
 - Cover large energy range
- **SiPMs**: Silicon Photomultipliers and arrays (MPPC)
 - Work only in the optical range (450nm), QE=20-50%
 - Expensive to cover large area (pixels)
- SC Nanowire Single-Photon Detectors (SNSPDs)
 - Photon energy sensitivity tunable (sensitive down to $\lambda \sim 1 \mu m$)
 - QE: 90% (or better)
 - Timing: 10-100ps
 - Rates: 100MHz (at max QE)
 - Insensitive to gamma rays, X-rays!

SiPMs: 可見光 到 near 紅外線

- SiPMs: Silicon Photomultipliers.
 - Work in the optical range (450nm), QE=20-50%
 - Expensive to cover large area (pixels)

• Multi-Pixel Photon Counters, MPPC.



These are arrays of SiPMs

Range of sensitivity: ~300nm to 900nm (HPK)

Various SC single photon sensors

- transition edge sensors (TES) (jitter 100ns, duration ~µsec)
- superconducting tunnel junctions (STJ),
- microwave kinetic inductance detectors (MKID),
- superconducting nanowire single-photon detectors (SNSPD).
 (jitter 10ps, no dead time, λ~1µm)

However, no sensitivity at λ =10µm

- Secure quantum optical communications systems often rely on transmission through optical fibers. (https://www.laserfocusworld.com/)
- However, certain applications, such as military communications, will require free-space versions of such systems. Because of atmospheric transmission windows in the mid-infrared (λ~10µm), they require high-speed mid-IR singlephoton detectors.

Dark Matter Searches

1KPixel SNSPD array (1x1mm²)



Fig. 1. a) Schematic of the row-column array. b) Optical micrograph of the fabricated array showing the pixel pitch and size. c) Chip-scale layout of the array showing the Nb leads (teal), Au bond pads (yellow), and WSi column inductors (red). d) Fabrication flow, as described in the text. The SNSPD meander and layer thicknesses are not shown to scale.

Summary

- In Taiwan we have expertise in various technologies, not only Silicon.
- I very briefly summarized some "old" and new technologies that are now leading to important real-life applications.
- Please follow the relevant presentations in this and other sessions.

Extra Slides

Commercial SNSPD





Electromagnetic Cascade



Courtesy: RM.Brown (RAL)

Calorimeter Types

There are two general classes of calorimeter: Sampling calorimeters:

Layers of passive absorber (such as Pb, or Cu) alternate with active detector layers such as Si, scintillator or liquid argon



Homogeneous calorimeters:

A single medium serves as both absorber and detector, eg: liquified Xe or Kr, dense crystal scintillators (BGO, PbWO₄), lead loaded glass.



EM Calo energy resolution



CMS High Granularity Calorimeter

Active Elements:

- Hexagonal modules based on Si sensors in CE-E and high-radiation regions of CE-H
- "Cassettes": multiple modules mounted on cooling plates with electronics and absorbers
- Scintillating tiles with SiPM readout in low-radiation regions of CE-H

Key Parameters:

Coverage: 1.5 < |η| < 3.0 ~215 tonnes per endcap Full system maintained at -30°C ~620m² Si sensors in ~30000 modules ~6M Si channels, 0.5 or 1cm² cell size ~400m² of scintillators in ~4000 boards ~400k scint. channels, 4-30cm² cell size Power at end of HL-LHC: ~125 kW per endcap



Electromagnetic calorimeter (CE-E): Si, Cu & CuW & Pb absorbers, 28 layers, 25 X_0 & ~1.3 λ Hadronic calorimeter (CE-H): Si & scintillator, steel absorbers, 22 layers, ~8.5 λ



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HGCAL Modules

Hexaboard Silicon sensor Kapton sheet

Base plate



8 inch HGCAL Silicon module assembly set-up (At one of the 6 module assembly centers worldwide)



HGCAL is an imaging Calo



Real-time fast electronics



Low gain shaper pulse (left) vs High Gain pulse (right) for 300GeV electrons. The model pulse has been extracted by sampling pulses at 1nsec.



$$S(t) = \begin{cases} A_0 \left[\left(\frac{t-t_0}{\tau} \right)^n - \frac{1}{n+1} \left(\frac{t-t_0}{\tau} \right)^{n+1} \right] e^{-\alpha(t-t_0)/\tau} & \text{if } t > t_0 \\ 0 & \text{otherwise} \end{cases}$$

Dedicated injection runs on test stands with waveforms sampled at 1nsec.

Step 5: use muons to get ADCperMIP

- The hit energy is estimated using a preliminary HG-MIP calibration.
- Hits with more than 0.5 MIP, corresponding to 20-25 HG ADC of the reconstructed waveform amplitude are visualised.
- (A hit-energy-colour bar could be added.)



Figure: Event display of a 200 GeV/c muon traversing the CE-E (28 layers) and CE-H (12 layers) prototypes during the beam test of October 2018. The incoming muon enters the detector from the left-hand side.

Pad energy reconstruction: LG,HG,ToT



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HGCAL is an imaging Calo

June 2018 run 407 - event 1: "150 GeV e-"



Micro-Strip Gas Chambers (MSGC)

